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ABSTRACT

The use of cryogenic silicon as a detector medium for dark matter searches is gaining popularity. Many of these searches are highly dependent on the value of the photoelectric absorption cross section of silicon at low temperatures, particularly near the silicon bandgap energy, where the searches are most sensitive to low mass dark matter candidates. While such cross section data have been lacking from the literature, previous dark matter search experiments have attempted to estimate this parameter by extrapolating it from higher temperature data. However, discrepancies in the high temperature data have led to order-of-magnitude differences in the extrapolations. In this paper, we resolve these discrepancies by using a novel technique to make a direct, low temperature measurement of the photoelectric absorption cross section of silicon at energies near the bandgap (1.2 eV–2.8 eV).

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The photoelectric absorption cross section ($\sigma_{p.e.}$) of silicon at low temperatures is an important parameter for modern experiments that use cryogenic silicon as a substrate for the direct detection of dark matter. $1-5$ $1-5$ Several dark matter signal models depend on this parameter. We have discussed these models in more detail in Ref. [6,](#page-8-2) but we will highlight two of them here.

First, the hypothesized kinetic mixing of dark photons and Standard Model photons results in an expected interaction between dark photons and electrons with a cross section given by¹

$$
\sigma_{A'}(E_{A'}) = \frac{\varepsilon^2}{\beta_{A'}} \sigma_{\text{p.e.}}(E_{A'}), \qquad (1)
$$

where $E_{A'}$ is the dark photon's total energy, $\beta_{A'} = v_{A'}/c$ is the dark photon's relativistic beta factor, and *ε* is the kinetic mixing parameter.

Second, the expected cross section for the interaction of axionlike particles (ALPs) with electrons is given by $8,9$ $8,9$

$$
\sigma_a(E_a) = \sigma_{p.e.}(E_a) \frac{g_{ae}^2}{\beta_a} \frac{3E_a^2}{16\pi \alpha m_e^2 c^4} \left(1 - \frac{\beta_a^{2/3}}{3}\right),
$$
 (2)

where E_a is the ALP's total energy, $\beta_a = v_a/c$ is its relativistic beta factor, α is the fine structure constant, m_e is the mass of the electron, and g_{ae} is the axioelectric coupling of the ALP to the electrons.

Note that in both (1) and (2) , the interaction rate is directly dependent on the value of $\sigma_{\rm p.e.}$. We performed an exhaustive litera-ture search^{[10–18](#page-3-8)} for measurements of $\sigma_{p.e.}$ at low energies (< 10 eV), where silicon dark matter experiments are most competitive, but we found the data to be lacking for the temperature regime of interest (< 5 K). Although previous dark matter search experiments have attempted to account for the temperature dependence of $\sigma_{p,e}$ by extrapolating from the data found in the aforementioned literature search, $1/2$ discrepancies in the high temperature data have led to low temperature projections that differ by more than an order of magnitude at energies near the silicon bandgap. The result is a dominating uncertainty in any experimental sensitivity curve for dark matter models that depend on $\sigma_{p.e.}$. This limitation was the motivation for the direct measurement of $\sigma_{p.e.}$ at sub-Kelvin temperatures.

To measure *σ*p.e., we designed an experiment in which a monochromatic light beam was sent through several silicon "filters" with varying thicknesses. Then, by comparing the relative transmission, a value for $\sigma_{p,e}$ was obtained, free from many of the systematics that would be present in an absolute transmission measurement.

The experiment was performed in the same ³He cryostat used to previously measure charge propagation in silicon and germanium at low temperatures.[19–22](#page-3-8) The cryostat was retrofitted with a new 50/125 multi-mode fiber optic (FO) via a vacuum feedthrough. The FO was used to illuminate samples at the cold stage with various external light sources (LED/laser diode) of differing wavelengths (see [Table I\)](#page-4-0). At the base-temperature stage, the FO was directly coupled to a lens. The beam was focused to a diameter of ∼200 *μ*m onto a filter mount roughly 150 mm away via a 2-axis MEMS mirror, as illustrated in [Fig. 1.](#page-4-1) The MEMS mirror tilt controls the $x-y$ position of the incident beam on the filter mount, with the relaxed state set to the center of the filter mount. Thus, the angle of incidence to any radially symmetric point on the filter mount was the same.

The filter mount was made from a 6 cm² brass plate, illustrated in [Fig. 2.](#page-5-0) The front side had eight 0.5 mm diameter through-holes radially symmetric to the mount center. Adjacent holes were 2 mm apart, center-to-center. The back side had $1.6 \times 1.6 \text{ mm}^2$ indents, each centered on a through-hole and used to mount a 1.5×1.5 mm² piece of silicon that was held in place with GE varnish. The silicon

TABLE I. In order to measure the photoelectric absorption cross section over a range of energies, a series of diodes with known wavelengths was used. The transmission curves provided by the manufacturer are summarized in the peak, lower halfmaximum (LHM), and upper half-maximum (UHM) columns. They were controlled with a Thorlabs DC2200 LED Driver.

Peak (nm)	LHM (nm)	UHM (nm)	Peak (eV)	Type
450	447	449	2.77	Laser
530	521	547	2.34	LED
639.5	639	640	1.94	Laser
660	651	667	1.88	LED
787	786	788	1.58	Laser
950	905	970	1.31	LED
972	970	973	1.28	Laser
1028	1027	1029	1.21	Laser

FIG. 1. The detector, which consisted of a 1 cm \times 1 cm \times 4 mm crystal of highpurity silicon, and the laser mechanism, which used a MEMS mirror to scan a focused beam of light pulses across the back face of the crystal in order to produce a 2D image. The crystal was biased via a parquet electrode on the illuminated face.

samples used in this work were cut from seven thinned, borondoped ($ρ$ < 100 Ω⋅cm) CZ Prime (100) wafers with thicknesses in micrometers of 5.1 ± 0.1 , 10.0 ± 0.1 , 24.0 ± 0.2 , 49.4 ± 0.1 , 100.2 ± 0.1 , 149.7 ± 0.2 , and 198.8 ± 0.1 . One indent remained empty for calibration purposes.

Approximately 3 mm behind the filter mount (relative to the oncoming photon beam) was a silicon crystal that acted as the detector. This crystal was cut from a 4 mm-thick wafer of undoped ultrahigh-purity float-zone silicon (∼15 kΩ-cm). The residual impurity was measured to be p-type with a concentration of 10^{12} cm⁻³. The front (facing the oncoming beam) and back faces of the crystal were $1 \text{ cm} \times 1 \text{ cm}$. The front face was patterned with an aluminum-tungsten mesh electrode, with 20% coverage, 23 which was used to bias the crystal to 50 V cm⁻¹. The back face was covered almost fully with an aluminum thin film that served as a ground electrode.

The silicon filters were individually illuminated with photons of different wavelengths by manipulating the MEMS mirror. The transmission through the silicon filters was measured as a charge signal in the silicon crystal detector. The charge was collected externally through an amplifier circuit by using the data acquisition system (DAQ).

The data-taking procedure was as follows. First, the fridge was set to the desired temperature, and a light source was connected to the fiber leading into the fridge. The options for light sources spanned a range of wavelengths, summarized in [Table I.](#page-4-0) Then, a run was performed at that temperature and wavelength. A run involved a scan of the beam spot over each hole, with each scan involving a 14×14 grid of individual measurements. To make a single measurement, the diode was pulsed in a train of 32 pulses using a Thorlabs DC2200 LED Driver. The pulses had widths of 20 *μ*s (some diodes required longer widths), spaced 8 ms apart. These pulses traveled down the fiber, out the focuser, and bounced off the MEMS mirror, which directed them through one of the holes in the filter mount. Then, some of the light from each pulse reflected off the silicon filter present in that hole, while another fraction of the light was absorbed

FIG. 2. Top: the front (facing the beam) of the filter mount featured 8 holes arrayed in a circular pattern. When the mirror was at rest, the beam spot fell in the center of the circle. This was done so that the angle of incidence of the beam at each hole (and therefore the amount of reflected light) was the same. At a distance of 2 mm radially outward from the empty hole, a calibration point was designated to measure spillover light from the beam spot into neighboring holes. Bottom: the back (facing the detector crystal) of the filter mount featured square indents aligned with each hole, which held pieces of silicon with different thicknesses. Each piece of silicon was held in place using two small spots of GE varnish at opposing corners.

by the filter. The remaining fraction was transmitted through the filter and detected.

To ensure proper alignment between the beam spot and the center of each hole, first a rough x–y value for each hole center was estimated, and then, a 14×14 grid of x-y positions was made for each hole, covering a 0.6 mm \times 0.6 mm area surrounding that hole's estimated center. Measurements were then taken at each point in

FIG. 3. A run using the 950 nm diode at 0.5 K. The run involved a scan over each hole containing a silicon filter. Each scan involved a set of 14×14 measurements so that the values corresponding to a precise alignment of the beam spot and the hole could be used for the analysis. The white text indicates the thickness of the silicon filter (in μ m) corresponding to each scan.

these grids in order that the maximum values for the charge collection, corresponding to precise alignment of the beam spot with a hole, could be used for the analysis.

Furthermore, to eliminate any temporal effects from biasing the results (such as a small increase in fridge temperature over the course of the run), rather than performing the scan over each hole one after another in sequence, the x–y points from all the separate scans were combined and shuffled so that the order of measurements favored no hole in particular.

To reduce the effect of charge buildup in the crystal over time, the crystal was grounded between every measurement. While grounded, the mirror was used to direct the beam spot toward the open hole, and a 1 ms flash of light was sent into the crystal to aid in the neutralization of the charge buildup. Then, the voltage was reapplied to the crystal so that the next measurement could be taken.

Since each measurement involved a train of 32 light pulses, each voltage trace recorded by using the DAQ was split into 32 sections and summed together to form an average pulse. The amplitude of the average pulse was used as a measure of the total amount of light transmitted through the silicon and collected by the crystal during that measurement.

In order to compare two different pulse amplitudes, an absolute calibration of the detector response was needed. This was done in two steps. First, a diode was connected to the system, and the mirror directed the beam spot toward the open hole. Then, a sweep over applied current to the diode was performed, and the average pulse size at each value of the applied current was observed and recorded. Second, the same diode was placed in a dark box with a photomultiplier tube capable of counting single photoelectrons. Using the same sweep over applied current as before, an absolute measure of the crystal response to a given amount of light was obtained. What was found was that the crystal responds linearly with

incident light up until average voltage pulses of 2 V, after which it begins to saturate. In the majority of runs, the width of the laser pulses was tuned so that the pulse sizes remained within this linear range, but in some cases, the average pulse amplitude extended outside this range, and the absolute calibration was used to correct that amplitude.

The average amplitudes from all the measurements in each scan were then used to produce a 2D image of that scan to visually confirm that the scan was in fact aligned with a hole. The set of scan images for one of the runs can be seen in [Fig. 3,](#page-5-1) where a decrease in amplitude is seen as the thickness of silicon increases.

To turn a set of scans into a value for the photoelectric absorption cross section, a series of post-processing steps was performed.

First, the set of 14×14 points for each scan was divided into thirds based on the time of acquisition, representing the first third of points taken for that scan, the second third, and the final third. Since the points for all the scans were taken in a random order, this process effectively separated each scan into 3 "sub-scans" of lower resolution.

Second, in order to reduce the impact of outliers, the median of the top 5 amplitudes for each sub-scan was taken as the transmission value for that sub-scan. Finally, these three sub-scan transmission values were taken together, and the median of those values was taken as the transmission value for the whole scan. This reduced the impact of any transient effects at the start of a run that were present in only the first sub-scan.

Once these transmission values were obtained, they were plotted against the corresponding silicon thickness. The results from several runs taken at 0.5 K are shown in [Fig. 4](#page-6-0) (top). Note that some runs include more points than others. This is because the shorter wavelength light used for some of the runs could not be detected through the thicker pieces of silicon.

The error bars for these points were the result of a detailed study, which checked for biases introduced by various effects, such as bias voltage, light intensity, linearity correction, neutralization procedure, and day-to-day variability. However, due to the symmetric nature of the data-taking process, these were all found to be sub-dominant to the primary source of error, which was caused by the filter mount itself. This was determined by performing a calibration run where each hole of the filter mount was left empty. The standard deviation in the light collection through the eight holes in this case was measured to be ∼3%, with a small dependence on the wavelength. A run with another mount produced by the same machining process resulted in a different variation from hole to hole but with the same overall magnitude of variation. Since this was the dominant source of error, the standard deviation of light collection found in this calibration run was used to set the error bars in [Fig. 4](#page-6-0) (top).

After plotting, the points were fit with an exponential according to the Beer–Lambert law,

$$
Ae^{-\rho\sigma_{\text{p.e.}}x},\tag{3}
$$

where A (arbitrary constant) and $\sigma_{p,e}$ are fit parameters, ρ is the density of silicon (2.33 g cm^{-3}), and x is the silicon thickness.

These fitted values for $\sigma_{p,e}$ at 0.5 K are shown in [Fig. 4](#page-6-0) (bottom). Each fitted value is presented as an ellipse, with the height

FIG. 4. Top: the normalized transmission through the different thicknesses of silicon for multiple wavelengths of light at 0.5 K. The error bars are dominated by systematic errors introduced by the filter mount. The negative of each fitted slope gives the value of the photoelectric absorption cross section at the corresponding wavelength. Bottom: the values of *σ*p.e. at 0.5 K from above, plotted in energy space. Each fitted value is presented as an ellipse, with the height representing the uncertainty of the fit and the width representing the uncertainty in the diode wavelength.

representing the statistical uncertainty in the fit and the width representing the uncertainty of the diode energy. For the energy uncertainty, the lower and upper bounds were calculated from the upper half-maximum wavelength and lower half-maximum wavelength of the emission spectrum, respectively (see [Table I\)](#page-4-0).

The photoelectric absorption cross section is not expected to differ significantly between 0 K and the 0.5 K results presented in this paper. However, it does increase at warmer temperatures. We confirmed this effect by repeating the 0.5 K measurements at 5 K, 77 K, and 295 K. We also performed some continuous measurements at a fixed wavelength as the fridge was warming up. These data are summarized in [Fig. 5.](#page-7-0) We did not measure a

FIG. 5. Top: measurements of $\sigma_{p.e.}$ at four discrete temperatures and the results of a simultaneous fit across all four temperatures using the model described in the text. Middle: the temperature dependence of $\sigma_{p,e}$ relative to $T = 0.5$ K. The cross section for 787 nm was measured continuously as the fridge warmed up, while the cross sections for the other wavelengths were only measured at four discrete temperatures. We did not measure a statistically significant difference in the cross section for temperatures of 77 K and below. Bottom: when the model includes an independent parameter for the first indirect bandgap proportionality constant (*A*1) at each of the four measured temperatures, the fitted values follow an exponential curve.

statistically significant difference in $\sigma_{p.e.}$ for temperatures up to 77 K but did observe an upward trend in *σ*p.e. between 77 K and 295 K.

To set a dark matter limit, a continuous curve in *σ*p.e.–energy space is preferred. To obtain this curve, we fit the discrete measurements to a model describing the temperature-dependent absorption coefficient $\alpha(T)$ via direct and indirect photon absorption, $²$ </sup>

$$
\alpha(T) = \sigma_{p.e.}(T)\rho_{Si} = \sum_{i,j=1,2} C_i A_j \left[\frac{(E_y - E_{gi}(T) + E_{pi})^2}{e^{E_{pi}/kT} - 1} + \frac{(E_y - E_{gi}(T) - E_{pi})^2}{1 - e^{-E_{pi}/kT}} \right] + A_d (E_y - E_{gd}(T))^{1/2}, \quad (4)
$$

where E_y is the photon energy, k is the Boltzmann constant, the first and second terms in the sum describe indirect photon absorption via phonon absorption and emission, respectively, and the last term describes direct photon absorption. The suffix i refers to the two phonon energies from the transverse acoustic (TA) $(E_p = 18.27 \text{ meV})$ and transverse optical (TO) $(E_p = 57.73 \text{ meV})$ lattice waves considered, and the suffix j refers to the two different indirect bandgaps E_g , which may be active in phonon absorption. We did not explicitly include in the model any direct contributions from possible B_5O_2 complexes^{[25,26](#page-3-8)} in the CZ-grown silicon filters. The C_i coefficients describe the electron–phonon coupling constant; for silicon, C_{TA} = 5.5 and C_{TO} = 4.0. The A_1 , A_2 , and A_d coefficients are used as proportionality constants.

The temperature-dependent indirect bandgap energies $E_{gi}(T)$ are given by

$$
E_{gj}(T) = E_{gj}(0) - \frac{\beta T^2}{T + \gamma},
$$
\n(5)

where β = 7.021 × 10^{-4} eV K⁻¹ and γ = 1108 K. To improve the fit of the model to the lower energy measurements, we allowed the lowest bandgap energy at 0 K $[E_{g1}(0)]$ to float while using the fixed value of $E_{g2}(0) = 2.5$ eV for the second indirect bandgap energy, where there is no enough data to constrain.

The model was fit simultaneously to the four $\sigma_{p.e.}$ measurements taken at 0.5 K, 5 K, 77 K, and 295 K, taking into account the uncertainties in the measured $\sigma_{p.e.}$ values as well as the uncertainties due to the diode wavelength distributions (see [Table I\)](#page-4-0). In this fit, $E_{g1}(0)$ was held constant across temperatures, but in order to investigate a possible temperature dependence in A_1 , we allowed A_1 to vary. Only one measurement was taken at an energy above the second indirect bandgap, so the A_2 temperature dependence was not investigated.

The results of the fit for A_2 and $E_{g1}(0)$ are 6(3) × 10³ eV² cm⁻¹ and 1.134(4) eV, respectively. The fit results for A_1 at each of the four temperatures are shown in [Fig. 5](#page-7-0) (bottom) and demonstrate a significant temperature dependence. This may be a result of temperaturedependent effects that the phenomenological absorption model described in Eq. [\(4\)](#page-7-1) does not account for, such as the effect of temperature on the density of states and the electron–phonon coupling. In order to improve the model's fit to the $\sigma_{p,e}$ measurements and produce a result that can be used for dark matter searches, we performed a second iteration of the simultaneous fit, this time constraining A_1 to have an exponential temperature dependence,

$$
A_1(T) = c_0 e^{-c_1 T}.
$$
 (6)

Using the previously determined $E_{g1}(0)$ and A_2 as fixed parameters, the fitted c_0 and c_1 values are

$$
c_0 = 325(6) \text{ eV}^{-2} \text{ cm}^{-1},
$$

\n
$$
c_1 = 1.7(1) \times 10^{-3} \text{ K}^{-1}.
$$
\n(7)

The result of this fit is shown in [Fig. 5.](#page-7-0) We chose an exponential function for empirical reasons as it was physically plausible and required few variables to adequately fit the A_1 values.

The result of this second iteration of the simultaneous fit is shown compared to the data in [Fig. 4](#page-6-0) (bottom) and [Fig. 5](#page-7-0) (top).

In future work, finer sampling of the photo-electric cross section may be accomplished by modifying the readout to accommodate a filtered xenon flash lamp (TDS) or by modifying the integrator for use with a longer time-constant tunable light source with a conventional shutter, with switching times on the scale of milliseconds. The current work was restricted to pulses from singlewavelength diodes due to the nature of its AC-coupled charge amplifier, designed for fast charge transport measurements rather than integrated power.

Finally, with the active interest in using other (non-silicon) semiconductors in dark matter searches, $3,27-\overline{30}$ it is worth noting that the technique outlined in this paper can be easily extended to such materials by placing samples of that semiconductor in the filter mount. However, to probe the values of the cross section at photon energies below the silicon bandgap, a detector crystal with a smaller gap, such as germanium, would need to be used.

See the [supplementary material](https://www.scitation.org/doi/suppl/10.1063/5.0038392) for the data files containing the points and curves in [Fig. 5](#page-7-0) (top) and for a document describing them.

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DATA AVAILABILITY

The data that support the findings of this study are available within its [supplementary material.](https://www.scitation.org/doi/suppl/10.1063/5.0038392)

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